High Power Resistive Products

Terminations

AVX introduces its complete line of High Power Termination Products. All Products are designed and manufactured at our ISO 9001 Facilities. All products are tested in accordance with MIL-PRF-55342.

ELECTRICAL SPECIFICATIONS

Resistance: 50Ω standard ($10 \Omega - 200 \Omega$ available) **Resistance Tolerance:** $\pm 5\%$ standard ($\pm 2\%$ available) **Power:** 2 Watts through 225 Watts **Operating Temperature Range:** -55° C to $+150^{\circ}$ C **Temperature Coefficient:** < 150 ppm/°C **Low VSWR**

MECHANICAL SPECIFICATIONS

 Package: Surface Mount Chips, Chips, Leaded Chips, Flange Mount

 Substrate Material: Aluminum Nitride

 Process: Thin Film

 Resistive Material: Tantalum

 Terminals: Silver

 Cover: Alumina

 Mounting Flange: 100% Cu, Ni or Ag Plated

 Mechanical Tolerance: ±0.13 (0.005)

 RoHS Compliant

 SMT and Chip products, supplied on Tape and Reel

FLANGE MOUNT TERMINATIONS HOW TO ORDER



Contact factory for custom ratings and sizes.

POWER DERATING









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SURFACE MOUNT CHIP TERMINATIONS – RP9 SERIES



mm (inches)

AVX Part Number	W ±0.25 (0.010)	L ±0.25 (0.010)	T ±0.13 (0.005)	LT ±0.13 (0.005)	WT ±0.13 (0.005)	LA ±0.13 (0.005)	Frequency Range (GHz)	VSWR (Typ.)	Power Max** (Watts)
RP92010T0050GTTR	2.54 (0.100)	5.08 (0.200)	1.02 (0.040)	1.02 (0.040)	2.29 (0.090)	2.92 (0.115)	DC - 3.0	1.20:1	10W
RP92525T0050GTTR	6.22 (0.245)	6.22 (0.245)	1.02 (0.040)	0.76 (0.030)	3.18 (0.125)	4.32 (0.170)	DC - 4.0	1.25:1	20W

** Test Condition: Chip soldered to a via patch on a 30-mil-thick Rogers RO4350 board; Land surfaces at 100°C; maximum rated power applied. Specification: The resistance of the film shall change no more than 0.5% during and after a 1000-hr. Burn-in per Mil-PRF-55342.

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SURFACE MOUNT CHIP TERMINATIONS – RP9 SERIES



mm (inches)

LT

W

AVX Part Number	W ±0.25 (0.010)	L ±0.25 (0.010)	T ±0.13 (0.005)	LT ±0.13 (0.005)	WT ±0.13 (0.005)	LA ±0.13 (0.005)	Frequency Range (GHz)	VSWR (Typ.)	Power Max** (Watts)
RP93725T0050GTTR	6.35 (0.250)	9.53 (0.375)	1.02 (0.040)	1.27 (0.050)	3.18 (0.125)	6.60 (0.260)	DC - 2.2	1.20:1	30W
RP93737T0050GTTR	9.40 (0.370)	9.40 (0.370)	1.02 (0.040)	1.27 (0.050)	3.18 (0.125)	6.99 (0.275)	DC - 3.0	1.25:1	40W

** Test Condition: Chip soldered to a via patch on a 30-mil-thick Rogers RO4350 board; Land surfaces at 100°C; maximum rated power applied. Specification: The resistance of the film shall change no more than 0.5% during and after a 1000-hr. Burn-in per Mil-PRF-55342.

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